



REPLACEMENT SHEET

2/17

Geopolitical Concentration of Components



FIG. 2

REPLACEMENT SHEET

3/17

Supplier Concentration of Component

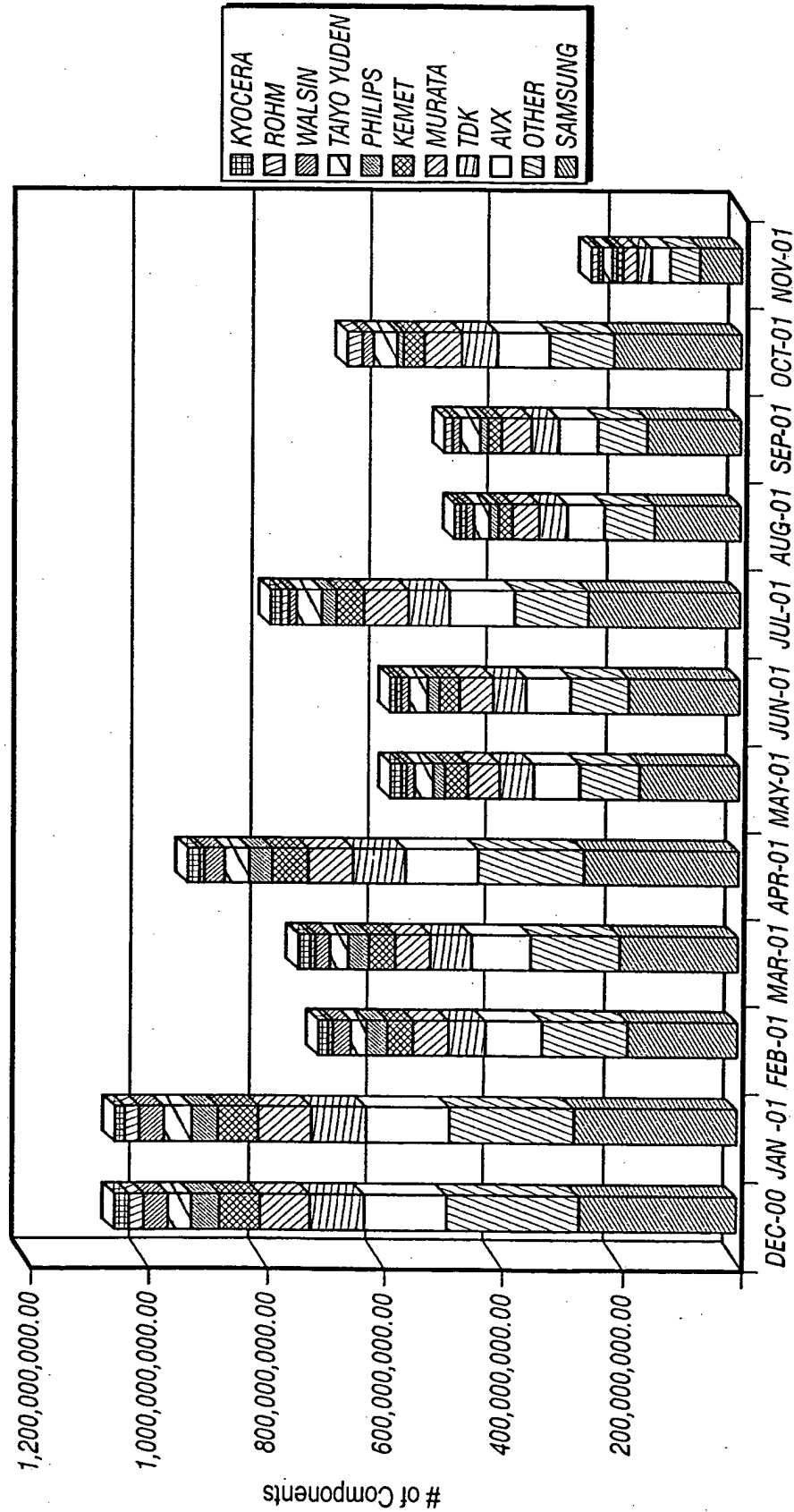


FIG. 3

REPLACEMENT SHEET

4/17

EINSTEIN BILL OF MATERIALS MANAGEMENT-DELL INTERNET EXPLORER
File Edit Window Sign Off Help
BACK FORWARD STOP REFRESH HOME
Address http://
SEARCH FAVORITES HISTORY MAIL UNDO EDIT
GO SEARCH

DELL
NEW BOH
REPORTS
EINSTEIN HELP
CURRENT USER: PATRICK LYNCH
CURRENT DATE: 16-NOV-2000
406

SELECT SUPPLIER
5322D (CRT-SC)
SHOW BOM
*INDICATES THAT THE BOM IS CURRENTLY CHECKED OUT
+INDICATES THAT THE CURRENT USER HAS THE BOM CHECKED OUT

COMPONENT MANUFACTURERS
VIEW MODE XML

SELECT MANUFACTURER 410
MANUFACTURER MIX 75%
MANUFACTURER LEAD TIME 14 DAYS
MANUFACTURER PART/NUMBER 1103-000156
414

MANUFACTURER DETAILS?
COMPONENT MANUFACTURER COUNTRIES OF ORIGIN
AVAILABLE COUNTRY LIST
TADIKISTAN
TANZANIA
UNITED STATES
JAPAN
TAIWAN
*LAST COUNTRY(COUNTRIES) WHERE MOST SIGNIFICANT VALUE ADD WAS PERFORMED
418

411
TRANSISTOR
TRANSISTOR
TRANSISTOR
TRANSISTOR
FET-SILICON:IRF634A,N,250V,8.1
FET-SILICON:IRF630,N,200V,10A
LED-ROUNDGRN,4,76MM,566N
IC-EEPROM:24C02,1KBIT,5V,DIP8
IC-OPAMP:324,DIP14P,300MIL,C
IC-VIDEO AMP:2506,DIP28P,500
IC-POSI,FIXED REG.:7805,TO-220
IC-POSI,ADJUST REG.:76R12,TO
IC-RESET:7045,TO-92,3P*,PLAS
IC-VERTICAL DEF:14A2142,SIP10
IC-HOR IVER,PROCESSOR:TD448
IC-OSD PROCESSOR:KS2501-09

404
SELECT BOM
412
416
418

DONE
PRESENTATION A
PRESENTATION B

FIG. 4A

408

5/17

EINSTEIN BILL OF MATERIALS MANAGEMENT-DELL INTERNET EXPLORER
File Edit Window Sign Off Help

BACK FORWARD STOP REFRESH HOME

ADDRESS http://

GO SEARCH

DELL
LABOUT EINSTEIN II NEW BOH REPORTS EINSTEIN HELP
CURRENT USER: PATRICK WNGCH CURRENT DATE: 16-NOV-2000

SELECT SUPPLIER
SAMSUNG

SELECT BOM
5322D (CRT-SC)
SHOW BOM

*INDICATES THAT THE BOM IS CURRENTLY CHECKED OUT
+INDICATES THAT THE CURRENT USER HAS THE BOM CHECKED OUT

I/C MANUFACTURER FAB/FOUNDRY NAME
API

TRANSISTOR
TRANSISTOR
TRANSISTOR
TRANSISTOR
FET-SILICON;IRF634A,N,250V,8.1
FET-SILICON;IRF630,N,200V,10A
LED-ROUNDGRN,4.76MM,566N
C-EEPROM24004512BBH,DIPS
C-OPAMP,324,DIP14P,300MIL,Q
C-VIDEO AMP,2506 DIP,28P,500
C-POS, FIXED REG.;7805 TO-220
C-POS,ADJUST REG.;76R12,TO
C-RESET,7045 TO-92,3P*,PLAS
C-VERTICAL DEF,14A2142,SIP,TO
C-HOR,IVER,PROCESSOR;TD448
C-OSD,PROCESSOR;KS2501-09

COMPONENT COSTS II
COMPONENT ATTRIBUTES II
COMPONENT DESCRIPTION
IC-EEPROM;24C04,,512X8BIT,DIP
COMPONENT TYPE
IC
PACKAGE TYPE
DIP14
CIRCUIT TYPE (MIXED SIGNAL)
80386
80486
80586
82C52
87C32

QUANTITY
1

TYPE
MIXED SIGNAL

SELECTED CIRCUIT TYPE (MIXED SIGNAL)
80386
80486
80586
82C52
87C32

DONE

?

?

?

FIG. 4B

408

420

421

422

425

424

423

REPLACEMENT SHEET

SELECT MONTH: ☒ MAY-OCT ☐ 510 6/17

COST	MAY	JUN	JUL	AUG	SEP	OCT
503 MATERIAL COST CALCULATED	0	0	0	0	0	0
502 MATERIAL COST						
LABOR COST						
OVERHEAD						
PROFIT						
504 FREIGHT	0	0	0	0	0	0
FREIGHT CALCULATED	0	0	0	0	0	0
FREIGHT COST						
INSURANCE						
FUEL						
SURCHARGE/CREDIT						
AIR (EXCEPTIONS)						
506 <input type="checkbox"/> SLC	0	0	0	0	0	0
SLC CALCULATED	0	0	0	0	0	0
STORAGE						
PALLET IN						
PALLET OUT						
PALLET CONFIGURATION						
2 WEEK BUFFER						
FINANCE						
508 WARRANTY						
SUPPLIER ABSORPTION						
<input type="checkbox"/> MISCELLANEOUS	0	0	0	0	0	0
MISCELLANEOUS CALCULATED	0	0	0	0	0	0
CORNER BOARD						
SLIP SHEETS						
PALLET PURCHASE						
PROCESSING FEE/HANDLING CHARGE						
BROKERAGE						
DECONTAINERIZATION						
NET TERMS						
REGIONAL PRODUCT ADDER						
HARBOR MAINTENANCE						

FIG. 5A

REPLACEMENT SHEET

8/17

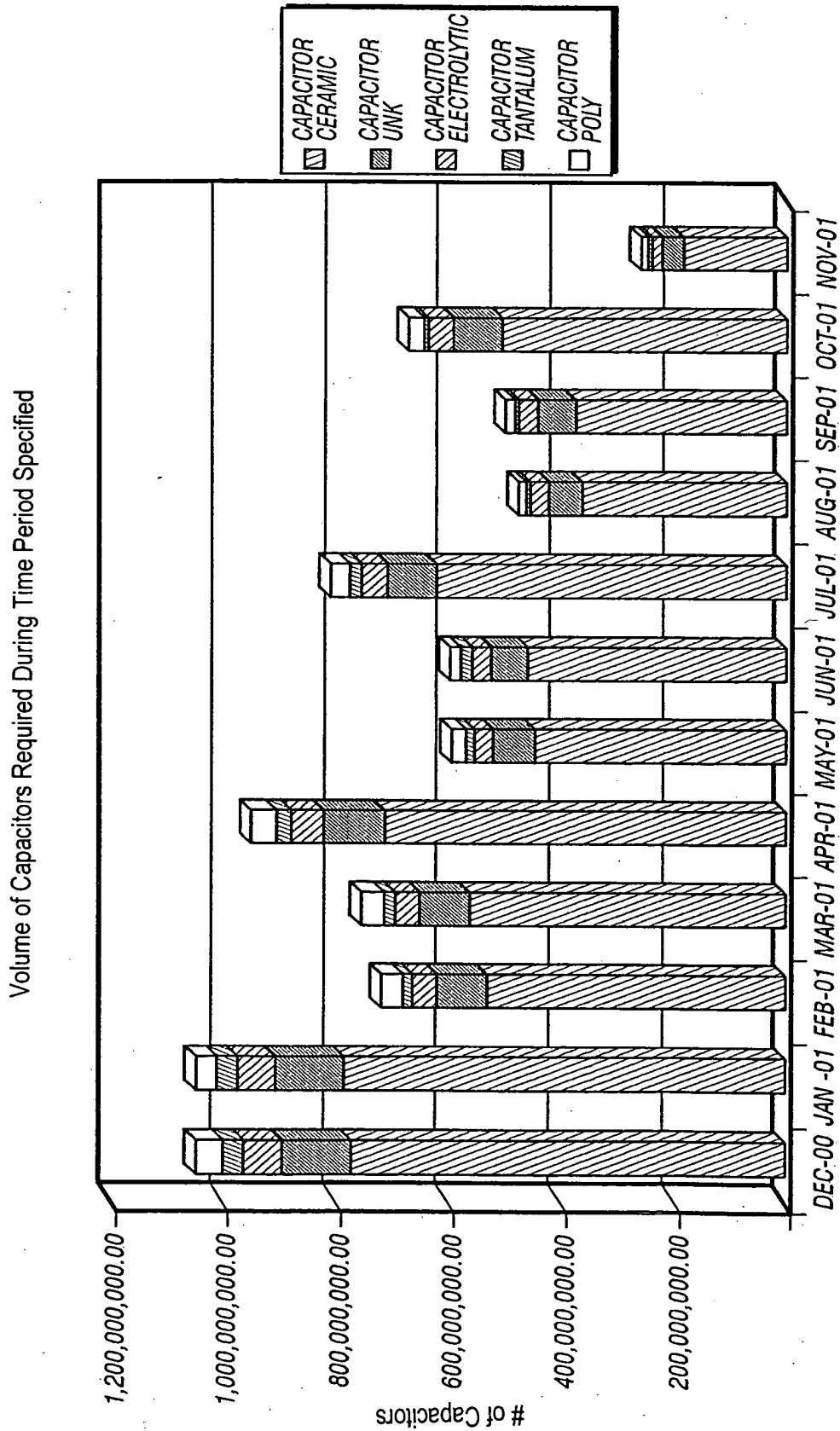


FIG. 8A

REPLACEMENT SHEET

9/17

Where Capacitors Used in Assembled Computer System

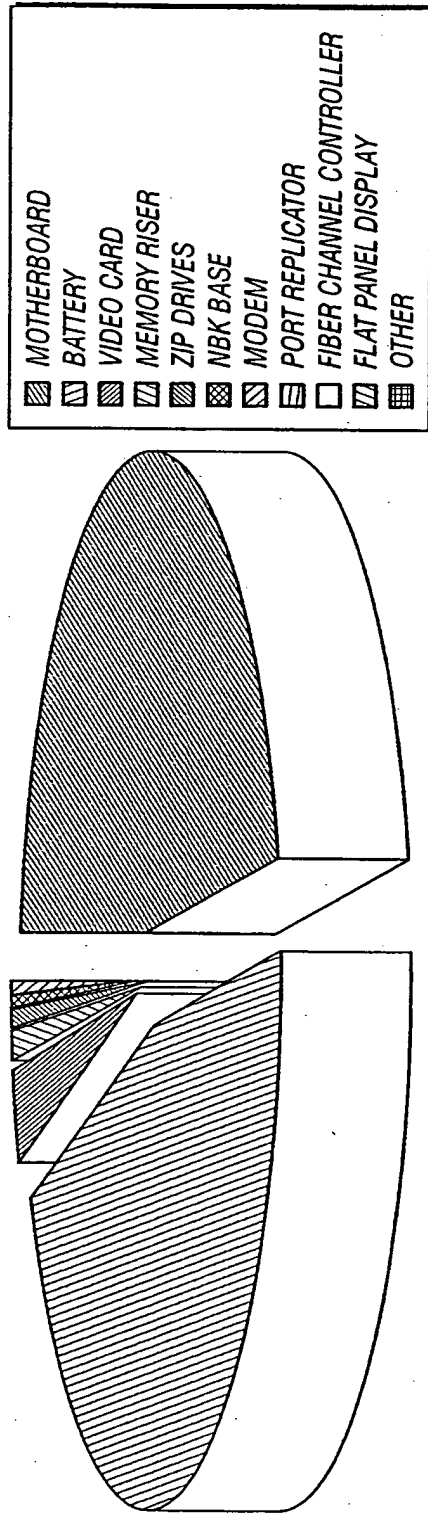


FIG. 8B

REPLACEMENT SHEET

10/17

Concentration of Capacitors Produced by Supplier

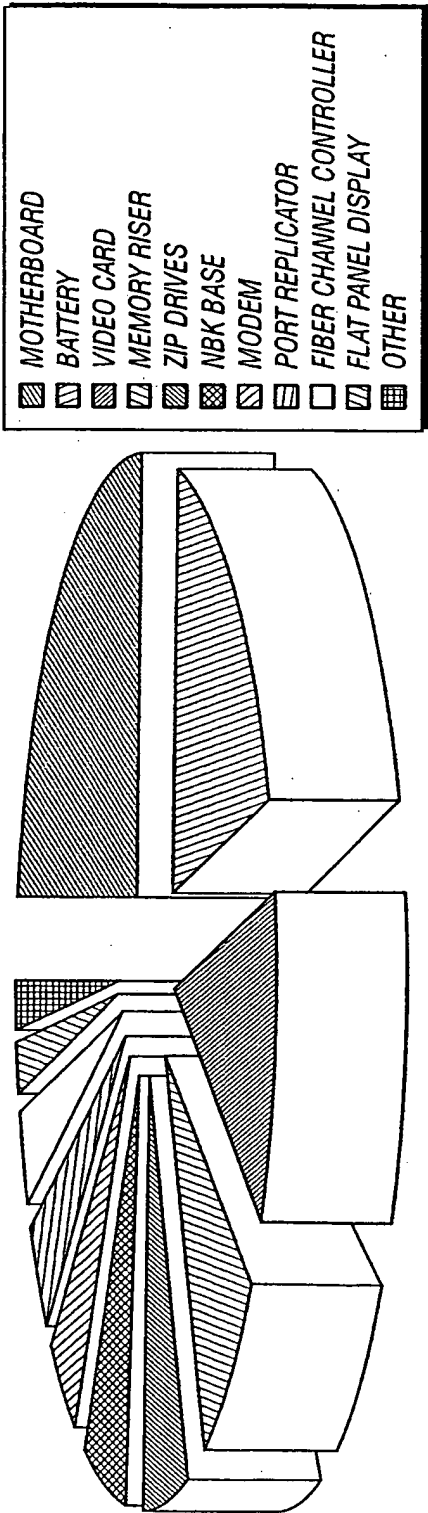


FIG. 8C

12/17

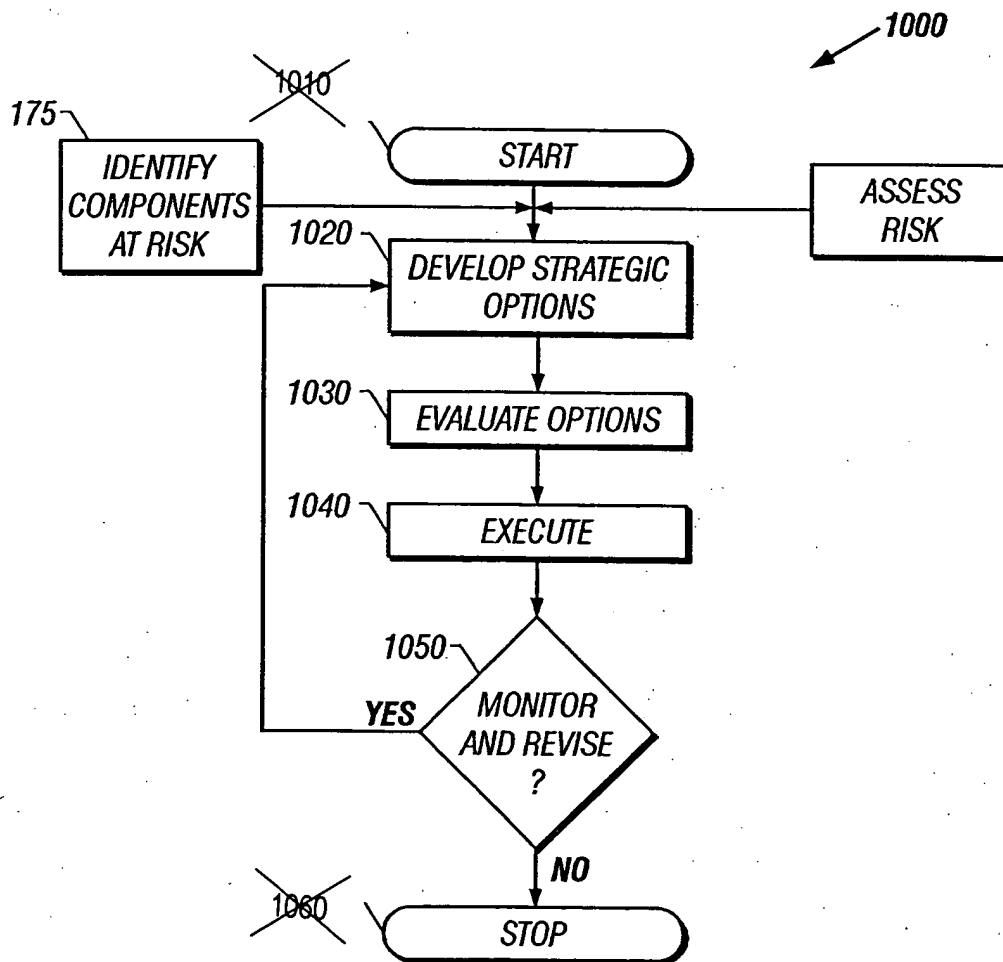


FIG. 10



REPLACEMENT SHEET

16/17

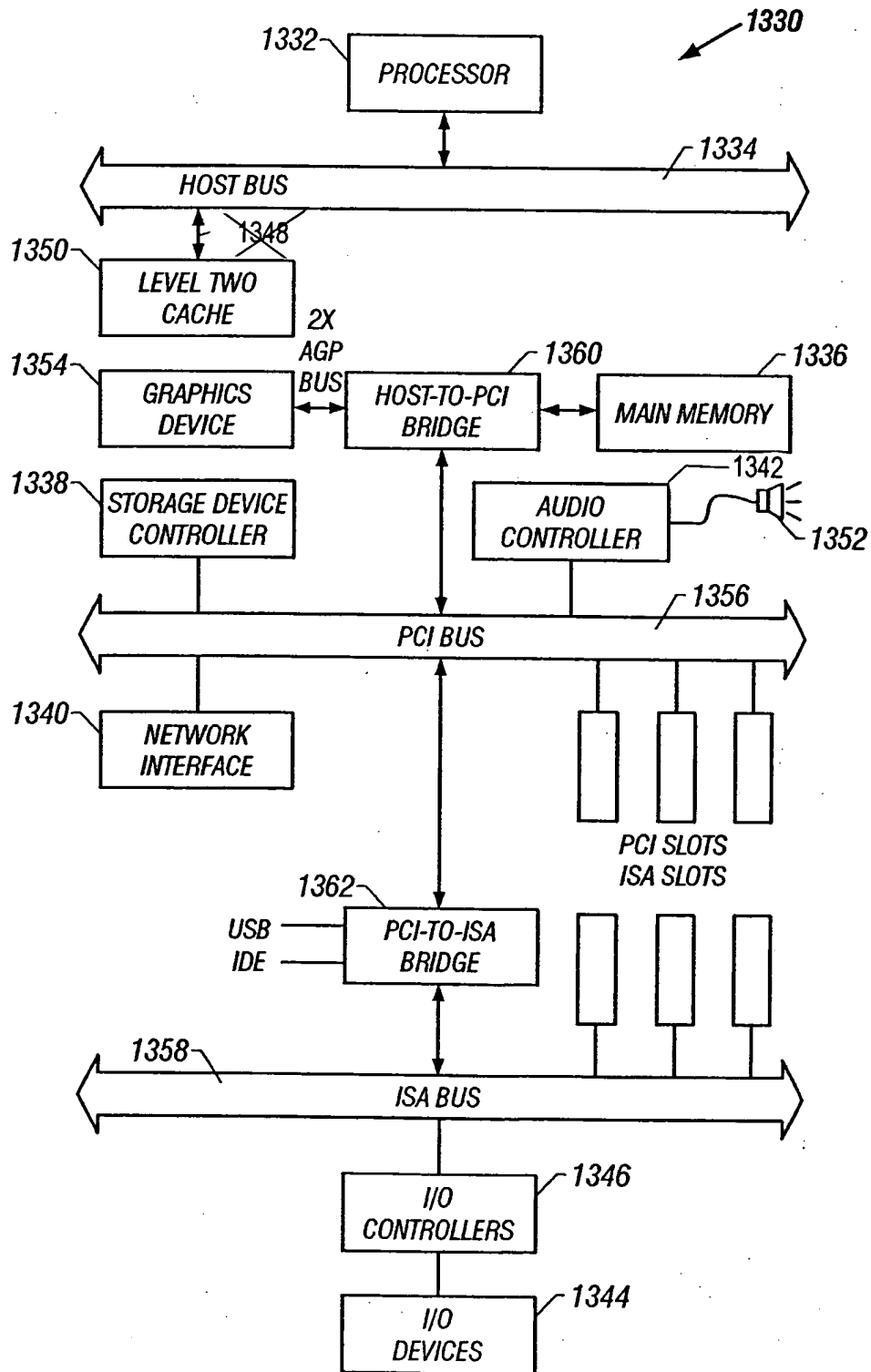


FIG. 13